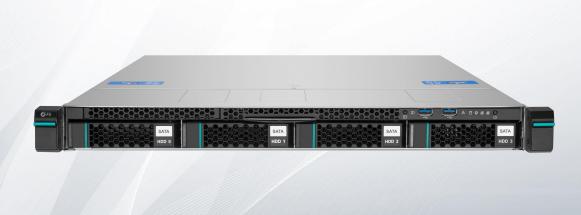
# **RS3110 RACK SERVER**

## HIGH CONFIGURATION AND WIDE RANGE OF APPLICATIONGS

The server can be easily reconfigured for multiple Enterprise and Data Center applications in Virtualization, Big Data, Analytics and Cloud Computing.



## Overview

RS3110 is a single-socket high-performance departmental server, using Intel C246 chipset, supporting 1 LGA-1151 (Socket H4), Intel I3/I5/I7/I9 8/9th generation processors, Intel Xeon-E-2100 /2200 series processors, this model supports a maximum memory capacity of 128GB, standard supports 4x 3.5-inch/2.5-inch SATA hot-swap hard disks, and can flexibly expand 3 PCI-E devices. It is suitable for small and medium-sized network applications of small and medium-sized enterprises and users in education, government, military, postal, railway, finance and other industries. The server can act as an e-mail server, WEB server, gateway, small and medium database application server, print server, etc. in the network.

## **Benefits**

- Intel I3/I5/I7/I9 8/9th generation processors,
- Intel Xeon-E-2100/2200 series Processors
- Intel<sup>®</sup> C246 Series chipset
- Up to 128GB of memory capacity
- Up to 4x 3.5-inch/2.5-inch SATA hot-swap hard disks
- Easily Expand with 1 PCle 3.0 Slots
- 2 network ports, 1 RJ45 remote management port

## **Main Highlights**

#### Intel I3/I5/I7/I9 8/9th Generation Processors, Intel Xeon-E-2100/2200 Processors

- Support hyper-threading technology, up to 16 threads when 8 cores.
- Support virtualized device input/output.
- (VT-d)----Increase the virtualization of device input/output on the basis of the previous virtualized CPU, which can effectively improve the performance and efficiency of the virtual machine.
- Kernel acceleration mode 2 (Turbo Mode).
- The kernel runs dynamically accelerated. The operation of the kernel can be turned on, off and accelerated as needed;
- Support Intel® SSE4.1, Intel® SSE4.2, Intel® AVX2 instruction set.
- Cache design----Three-level all-inclusive Cache design, L1 design is the same as Core micro-architecture; L2 adopts ultralow latency design, each core 256KB; L3 adopts shared design, all cores on the chip shared.
- Integrated Memory Controller (IMC)----Moved from the chipset to the CPU chip, it supports multi-channel DDR4 memory. Compared with the previous generation, the memory read delay is greatly reduced, and the memory bandwidth is greatly improved. up to three times.

#### Fast Channel—DMI Bus

DMI is a point-to-point connection technology that replaces the front-side bus (FSB); DMI adopts the serial mode as signal transmission, and adopts LVDS (low-voltage differential signaling technology, which is mainly used for high-speed digital signal interconnection, so that the signal can be transmitted in hundreds of Mbps or more) signaling technology; reliability, practicality and applicability guarantee the high availability of DMI; the bandwidth of 20-bit wide DMI can reach an astonishing 25.6GB per second per connection, which is far from comparable to FSB. Supports Intel Quick Assistant Technology (Intel® QAT) and Intel Advanced Vector Extensions 512 (Intel® AVX-512).

#### Virtualization Technology (VT)

Support virtualized device input/output (VT-d)--Increase the virtualization of device input/output on the basis of the
previous virtualized CPU, which can effectively improve the performance and efficiency of virtual machines. It provides a
strong guarantee for server integration, original data migration and security.

#### **Configure on Demand**

• According to the actual needs of users, provide the best configuration options.

### **High Availability**

With the processor Hyper Threading technology, it supports multi-threading and multi-tasking mode. The processor
integrates a DDR4 memory controller, providing a highly selectable memory solution. Provide IRST function to meet the
system's requirements for hard disk security, and consider user cost requirements. Integrated Intel server-class dual 1000M
network adapters, support link aggregation and binding redundancy functions, suitable for a variety of application
requirements.

#### **High System Scalability**

Support quad-core/six-core/eight-core Intel I3/I5/I7/I9 8/9th generation processors, Intel Xeon-E-2100/2200 series
processors, 4 DIMM memory slots can support up to 128GB Unbuffered DDR4 ECC 2666MHz Memory, the standard
system supports up to 4 SATA hard disk expansion positions (4 hot-swappable), providing a PCI-E interface to provide
users with expansion space.

#### Safety

• The motherboard provides TPM trusted module interface, users can choose according to their needs, and support Intel SGX (Software Guard Extensions) technology.

#### Manage

• Integrated BMC module, support IPMI2.0, provide 1 RJ45 management network port, support remote management, iKVM.

## **Cost-effective Solution**

RS3110 adopts a server motherboard based on Intel® C246 chipset, supports 1 LGA1151 Intel I3/I5/I7/I9 8/9 generation processors, Intel Xeon-E-2100/2200 generation processors, the motherboard provides 4 memory slots. The maximum support is 128GB DDR4 2666MHz ECC UDIMM; the motherboard naively supports 4 SATA3 (6Gbps) hard disk interfaces. Integrated dual Gigabit Intel server network card is very suitable for small and medium-sized enterprises, hosting platform.

## **Advanced Chassis Design Process**

It adopts short chassis design, which can be placed in network cabinets with a depth of 600mm and server cabinets with a standard depth; intelligent cooling system can effectively reduce noise pollution and create a constant temperature space for the cabinet; fully shielded anti-electromagnetic radiation, anti-interference, anti-static (EMI) design.

# Applicable to a Variety of Application Environments

RS3110 is a single-socket rack server with leading technology, suitable for small and medium-sized network applications of small and medium-sized enterprises and users in education, government, military, postal, railway, finance and other industries.

## **Technical Features: Host Performance**

Features	Technical Specification
СРИ	Intel I3/I5/I7/I9 8/9 generation processors, Intel Xeon-E-2100/2200 series CPU (LGA 1151)
Chipset	Intel® C246 Chipset Platform Controller Hub (PCH)
Intel®DMI speed	8 GT/s DMI3
RAM	DDR4 ECC/Unbuffered (UDIMM) 2666MHz RAM, up to 128GB
Memory Error Detection	Fix single-bit errors, detect double-bit errors
Hard Drives	Supports 4 hot-swap 3.5/2.5-inch hard drives
SATA RAID	Standard Configuration - No Raid card
Show	ASPEED AST2500 BMC
CD-ROM	One SATA interface thin optical drive
PCIE Expansion Slot	1 PCI-E 3.0 x8 (in x16)
M.2 Interface	1 PCI-E 3.0 x4 M.2 (2280/22110)
Network Card	Integrated Intel210-AT dual Gigabit high-speed Ethernet server card
Manage	Integrated BMC module, support IPMI2.0, provide a 10/100 Mbps RJ45 management network port, support iKVM, support remote management
Keyboard	USB Compatible with USB2.0
Mouse	USB Compatible with USB2.0
Power Supply	450W 1+1 redundant power supply

## **Extended Performance**

Features	Technical Specification
Expansion slot	Supports one PCI-E device (full-height full-length PCI-E 3.0 x8 (in x16))
Internal device interface	1x USB-type A port, 2x 2x5 pin USB 2.0 sockets (supports 1 to 2), 1x 2x5 pin USB 3.0 sockets (supports 1 to 2), 4x SATA3.0 6Gbps interfaces and 1x Serial port, 1 TPM trusted module interface
External device interface	1 VGA display port, 6 USB ports (2xUSB 2.0 on the front panel, 2xUSB 2.0 and 2xUSB 3.0 on the rear panel), 2 network ports, 1 COM, 1 RJ45 remote management port

# **Strict System Certification**

Features	Technical Specification
1	Windows Server 2012R2
2	Windows Server 2016 64bit
3	Red Hat* Enterprise Advanced Server 6.9 _x86 64bit
4	Red Hat* Enterprise Advanced Server 7.3_x86 64bit
5	Red Hat* Enterprise Advanced Server 7.4_x86 64bit
6	Red Hat* Enterprise Advanced Server 7.5_x86 64bit
7	Ubuntu 16.10
8	Ubuntu 17.04
9	Ubuntu 17.10

# **Environment and Specifications**

Features	Technical Specification
Ambient Temperature	Operating: 10°C to 35°C (50°F - 5°F)
	Non-operating: $-40^{\circ}$ C ~ $70^{\circ}$ C (- $40^{\circ}$ F ~ $158^{\circ}$ F)

Features	Technical Specification
Relative Humidity	Non-operating 95% non-condensing at 25°C to 30°C
Sound	In operation mode, the sound pressure measured in the lateral position is <50dBA; the sound intensity measured when the ambient temperature is <28 $^\circ$ C is 6.2BA
Electrostatic Discharge	15kv per Intel ambient temperature test specification

# **Power Supply**

Features	Technical Specification
Power Supply	450W server dedicated power supply
AC Voltage/Frequency	110~240V/60/50Hz 6~3A
+5V	1.0~ 15A
+12V	0.4~25A
-12V	0~ 0.5A
+3.3V	0.5~21A
+5VSB	0~2.5

## Structure

Features	Technical Specification
Shape System	1U rack type (with cabinet accessories)
High	1.7" (44mm)
Width	16.9" (430mm)
Depth	21.7" (550mm)
Weight	About 37lbs (17KG) (standard/gross weight)